# EP29LPSPAO Master Bond Polymer System

Two component, low viscosity epoxy for bonding, sealing, coating, potting and encapsulation

# **Key Features**

- √ Thermally conductive, electrically insulative
- √ Can withstand cryogenic shock

- √ High dimensional stability
- √ Vacuum compatible

### **Product Description**

Master Bond EP29LPSPAO is a two component, thermally conductive, electrically insulative, high performance epoxy system. It is specially formulated for cryogenic applications and requires a relatively low temperature heat cure. EP29LPSPAO is serviceable at temperatures as low as 4K as an adhesive, sealant, coating and encapsulant, but more importantly, it is able to withstand cryogenic shocks (i.e. room temperature down to liquid helium temperatures in a 5-10 minute time period). This low viscosity epoxy adheres well to a wide variety of substrates including metals, glass, ceramics and many different plastics, and is ideal for potting and encapsulation. The working life is exceptionally long; a 100 gram mass will allow over 5-7 hours of working life. EP29LPSPAO has superior electrical insulation properties and a good chemical resistance profile. The optimum cure schedule for EP29LPSPAO requires gelling the mixed epoxy at room temperature, followed by alternative lower elevated temperature cure cycles (8-10

hours at 130-150°F) or (5-7 hours at 175°F) or (3-5 hours at 200°F). EP29LPSPAO is widely used in applications where thermal conductivity and cryogenic serviceability are required. The mixed system is off white in color.

### **Product Advantages**

- Low mixed viscosity (thixotropic) and low exotherm; contains no solvents or diluents
- Serviceable at cryogenic temperatures down to 4K; can withstand cryogenic shocks
- Long working life at ambient temperatures
- Superior physical strength and electrical insulation properties
- High bonding strength to a wide variety of substrates
- Good chemical resistance to water, fuels, acids, bases and salts
- Ideal for potting and encapsulation applications

#### **Typical Properties**

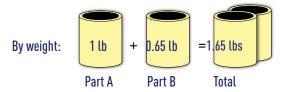
Tensile lap shear strength, aluminum to aluminum, 75°F	>1,000 psi
Tensile strength, 75°F	>5,200 psi
Tensile modulus, 75°F	>450,000 psi
Thermal conductivity, 75°F	9-10 BTU•in/ft²•hr•°F [1.30-1.44 W/(m•K)]
Coefficient of thermal expansion	22-27 x 10 <sup>-6</sup> in/in/°C
Volume resistivity, 75°F	>10 <sup>15</sup> ohm-cm
Dielectric constant, 75°F, 60 Hz	4.35
Hardness, 75°F	>75 Shore D
Service temperature range	4K to +275°F [4K to +135°C]

# **Mixing and Curing**

Mixing ratio, Parts A to B	100:65 by weight
Viscosity of Part A, 75°F	55,000-75,000 cps (thixotropic)
Viscosity of Part B, 75°F	2,500-20,000 cps (thixotropic)
Mixed viscosity of Part A and B, 75°F	4,000-15,000 cps
Working life after mixing at 75°F; 100 gram batch	5-7 hours
Cure schedule - Gel at room temp followed by any option listed below	
130-150°F	8-10 hours
175°F	5-7 hours
200°F	3-5 hours
Shelf life at 75°F, in original, unopened containers	6 months

### **Preparation of Compound**

Master Bond EP29LPSPAO is prepared for use by thoroughly mixing Part A with Part B in a 100:65 mix ratio by weight.



Mixing should be done slowly to avoid trapping air. All mixing should be performed in a low humidity work environment to prevent moisture pickup. The working life of a mixed 100 gram batch is 5-7 hours. It can be further lengthened by using shallow mixing vessels or mixing smaller size batches.

### **Preparation of Bonding Surfaces**

All bonding surfaces should be carefully cleaned, degreased and dried to achieve maximum bond strength. When bonding to metal surfaces, it is advisable to employ chemical etching to optimize adhesion. Non-porous surfaces should be roughened with sand paper or emery paper and solvent cleaned with acetone or xylene.

#### **Application and Assembly**

EP29LPSPAO is readily pourable for potting and casting applications. Castings can be made using silicone rubber, plastic or metal molds using mold release agents for easy removal. To remove air bubbles when potting, it is advisable to vacuum degas. When bonding or sealing, apply EP29LPSPAO with a brush, paint roller or spatula. Enough mixed adhesive should be applied to obtain a

final adhesive bond line thickness of 3-5 mils. This can be accomplished by coating one surface with an adhesive film 3-5 mils thick or by coating the two surfaces, each with a 1.5 to 2.5 mil thick layer of adhesive. Porous surfaces may require somewhat more adhesive to fill the voids than nonporous ones. Thicker glue lines do not increase the strength of a joint but do not necessarily give lower results as the EP29LPSPAO epoxy resin system does not contain any volatiles. The parts to be bonded should then be pressed together with just enough pressure to obtain and maintain intimate contact during cure without squeezing out the ероху.

#### Cure

Master Bond EP29LPSPAO is a modified heat cured system; the optimum cure schedule requires that the mixed material gel at room temp for 5-6 hours followed by any of the following options: 8-10 hours at 130-150°F, 5-7 hours at 175°F or 3-5 hours at 200°F. All excess material should be removed promptly with a spatula or knife before it hardens. Clean residue with a rag and solvent using acetone, xylene, or toluene.

#### **Packaging**

Product available in:

- 1/2 Pint kits
- Pint kits
- Quart kits
- Gallon kits
- 5 Gallon kits

Also available in special packaging including premixed and frozen syringes.



# **Handling and Storage**

All epoxy resins should be used with good ventilation and skin contact should be avoided. For safe handling details, please consult the product SDS. Optimum storage is at or below 75°F in closed containers. No special storage conditions are necessary. Containers should, however, be kept closed when not in use to avoid contamination. Cleanup of spills and equipment is readily achieved with aromatic or ketone solvents employing proper precautions of ventilation and flammability.

#### **Certifications**



# **Not to Be Used for Specification Purposes**

The values contained herein are considered typical properties only and are not intended to be used as specification limits. For assistance in preparing specifications, please contact Master Bond technical support for further details.

#### **Notice**

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